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(54) RADIATION SENSITIVE RESIN COMPOSITION

(57)Abstract:

PROBLEM TO BE SOLVED: To obtain a positive or negative radiation sensitive resin compsn. useful as a chemical amplification resist which ensures especially low edge roughness in a fine pattern of \leq 0.2 i m and has high sensitivity and high resolution.

SOLUTION: The positive radiation sensitive resin compsn. contains a fullerene deriv. soluble in a solvent for a resist, a radiation sensitive acid generating agent and an acid dissociable group—contg. resin or an alkali—soluble resin and an alkali solubility controlling agent. The negative radiation sensitive resin compsn. contains the fullerene deriv., the radiation sensitive acid generating agent, an alkali—soluble resin and a compd. capable of crosslinking the alkali—soluble resin in the presence of an acid.

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